PTO-1595 F	SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
To the Honorable Commissioner of Fundamental 1022843	52 attached original documents or copy thereof.
1 Name of conveying party(ies):	2 Name and address of receiving party(ies):
Chien-Jung Wang Shih-Liang Wang Chao-Hao Cheng	Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3 Nature of conveyance: ■ Assignment	Additional name(s) & address(es) attached □ Yes ⊠ No □
☐ Security Agreement ☐ Change of Name	
Other: Execution Date: Sept. 23, 2002	
4 Application number(s) or patent number(s):	
If this document is being filed together with a new application	n, the execution date of the application is:09-23-02
A. Patent Application No(s).	B. Patent No(s)
5 Name and address of party to whom correspondence concerning document should be mailed:	ttached? □ Yes ☒ No 6 Total number of applications and patents involved:
RANDY W. TUNG Tung & Associates	7 Total fee (37 CFR 3.41) \$40.00
838 W. Long Lake Road Suite 120	□ Enclosed
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Randy W. Tung Name of Person Signing Registration No. 31,311 Signature	November 6, 2002 Date
	ber of pages including cover sheet, attachments, and document : 3

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

ASSIGNMENT

WHEREAS, we, <u>CHIEN-JUNG WANG, SHIH-LIANG WANG and CHAO-HAO</u>

<u>CHENG</u>, have invented certain improvements in

METHOD AND APPARATUS FOR STRESS TESTING INTEGRATED CIRCUITS

USING AN ADJUSTABLE AC HOT CARRIER INJECTION SOURCE

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, CHIEN-JUNG WANG, SHIH-LIANG WANG and CHAO-HAO CHENG, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 23 day of 5ept., 2002,

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PATENT REEL: 013485 FRAME: 0300 67,200-935 2001-1124

preparatory to obtaining Letters Patent of the United States thereon, and in and to said application

and any Letters Patent that may be granted in pursuance of said application and any divisional,

continuation or continuation-in-part application thereof, and in and to any reissue of any such patent,

and in and to any patent applications which may be filed on said invention in countries foreign to the

United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention

in its own name or through its designees, including subsidiaries, related companies or assignees,

under the International Convention or otherwise, and we further agree to execute all papers,

including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

Chao-hao Cheng CHAO-HAO CHENG

Chien-Jung Wong Shih-Liang Wang Shih-Liang Wang

TUNG & ASSOCIATES 838 W. Long Lake Road

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RECORDED: 11/06/2002